

Engineering Specification

Type 15.0 SXGA+ Color TFT/LCD Module Model Name: N150P3-L01

Document Control Number: OEM I-N150P3-L01-02

Note: Specification is subject to change without notice. Consequently it is better to contact International Display Technology before proceeding with the design of your product incorporating this module.

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i Record of Revision

Date	Document Revision	Page	Summary
June 27,2003	OEM I-N150P3-L01-01	All	First Edition for customer.
September 11,2003	OEM I-N150P3-L01-02		To update
		5	Power Consumption
			Typical Power Consumption
		7	CFL Current Max
		24	9.0 Power Consumption
		26,27	Reference Drawings
		28	12.0 National Test Lab Requirement



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1.0 Handling Precautions

- If any signals or power lines deviate from the power on/off sequence, it may cause shorten the life of the LCD module.
- The LCD panel and the CFL are made of glass and may break or crack if dropped on a hard surface, so please handle them with care.
- CMOS-ICs are included in the LCD panel. They should be handled with care, to prevent electrostatic discharge.
- Do not press the reflector sheet at the back of the LCD module to any directions.
- Do not stick the adhesive tape on the reflector sheet at the back of the LCD module.
- Please handle care when mount in the system cover. Mechanical damage for lamp cable and for lamp connector may cause safety problems.
- Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (2.5, IEC60950 or UL60950), or be applied exemption conditions of flammability requirements (4.7.3.4, IEC60950 or UL60950) in an end product.
- The LCD module is designed so that the CFL in it is supplied by Limited Current Circuit (2.4, IEC60950 or UL60950).
- The fluorescent lamp in the liquid crystal display(LCD) contains mercury. Do not put it in trash that is disposed of in landfills. Dispose of it as required by local ordinances or regulations.
- Never apply detergent or other liquid directly to the screen.
- Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth; do not use solvents or abrasives.
- Do not touch the front screen surface in your system, even bezel.
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 - The information contained herein may be changed without prior notice. It is therefore
 advisable to contact International Display Technology before proceeding with the design of
 equipment incorporating this product.



General Description 2.0

This specification applies to the Type 15.0 Color TFT/LCD Module 'N150P3-L01'.

This module is designed for a display unit of notebook style personal computer.

The screen format and electrical interface are intended to support the SXGA+(1400(H) x 1050(V)) screen. Support color is native 262K colors (RGB 6-bit data driver).

All input signals are LVDS (Low Voltage Differential Signaling) interface compatible.

This module does not contain an inverter card for backlight.

2.1 **Characteristics**

The following items are characteristics summary on the table under 25 degree C condition:

CHARACTERISTICS ITEMS	SPECIFICATIONS
Screen Diagonal [mm]	380.625
Pixels H x V	1400(x3) x 1050
Active Area [mm]	304.5(H) x 228.375(V)
Pixel Pitch [mm]	0.2175(per one triad) x 0.2175
Pixel Arrangement	R,G,B Vertical Stripe
Weight [grams]	575 Typ., 600 Max.
Physical Size [mm]	317.3(W) x 242.0(H) x 6.2(D) Typ./6.5(D) Max.
Display Mode	Normally Black
Display Surface Treatment	AG160
Support Color	Native 262K colors (RGB 6-bit data driver)
White Luminance [cd/m ²] (center)	200 Typ. (Icfl=6.5mA)
Contrast Ratio	400 : 1 Тур.
Optical Rise Time + Fall Time [msec]	60 Typ., 120 Max.
Nominal Input Voltage VDD [Volt]	+3.3 Тур.
Power Consumption [Watt](VDD)	2.0 Typ., 2.5 Max. (VDD=3.3[V])
Lamp Power Consumption [Watt]	4.1 Typ., 4.5 Max. (W/o inverter loss)
Typical Power Consumption [Watt]	6.1 Typ., 6.6 Max. (W/o inverter loss). (VDD=3.3[V])
(VDD Line + VCFL Line)	
Electrical Interface	8 pairs LVDS (Even/Odd R/G/B Data(6bit), 3sync signals, Clock)
Temperature Range [degree C]	
Operating	0 to +50
Storage (Shipping)	-20 to +60
CFL Cable Length [mm]	40 Тур



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2.2 Functional Block Diagram

The following diagram shows the functional block of this Type 15.0 Color TFT/LCD Module.

The first LVDS port transmits even pixels while the second LVDS port transmits odd pixels.





3.0 **Absolute Maximum Ratings**

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	VDD	-0.3	+4.0	V	
Input Signal Voltage	VIN	-0.3	VDD+0.3	V	
CFL Ignition Voltage	Vs	-	+2,000	Vrms	(Note 2)
CFL Current	ICFL	-	7	mAms	
CFL Peak Inrush Current	ICFLP	-	20	mA	
Operating Temperature	TOP	0	+50	deg.C	(Note 1)
Operating Relative Humidity	HOP	8	95	%RH	(Note 1)
Storage Temperature	TST	-20	+60	deg.C	(Note 1)
Storage Relative Humidity	HST	5	95	%RH	(Note 1)
Vibration			1.5 10-200	G Hz	
Shock			50 18	G ms	Rectangle wave

Absolute maximum ratings of the module is as follows:

Note 1: Maximum Wet-Bulb should be 39 degree C and No condensation.

Note 2: Duration : 50msec Max. Ta=0 degree C

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4.0 Optical Characteristics

The optical characteristics are measured under stable conditions as follows under 25 degree C condition:

Item	Conditions			Specification		
				Тур.	Note	
Viewing Angle	Horizontal		(Right)	85	-	
(Degrees)	K <u>≥</u> 10		(Left)	85	-	
	Vertical		(Upper)	85	-	
K: Contrast Ratio	K <u>≥</u> 10		(Lower)	85	-	
Contrast ratio				400	-	
Response Time (ms)	Rising + Fa	alling		60	-	
Color	Red	х		0.569	-	
Chromaticity	Red	у		0.332	-	
(CIE)	Green	х		0.312	-	
	Green	у		0.544	-	
	Blue	х		0.149	-	
	Blue	у		0.132	-	
	White	х		0.313	-	
	White	у		0.329	-	
White Luminance (cd/m ²)				200 Тур.	-	



5.0 Signal Interface

5.1 Connectors

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	JAE
Type / Part Number	FI-XB30SL-HF10
Mating Receptacle Manufacture	JAE
Mating Receptacle/Part Number	FI-X30M

Connector Name / Designation	For Lamp Connector		
Manufacturer	JST		
Type / Part Number	BHSR-02VS-1		
Mating Type / Part Number	SM02B-BHSS-1		



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5.2 Interface Signal Connector

Pin #	Signal Name
1	GND
2	VDD
3	VDD
4	V _{EEDID} (Note 2,3)
5	Reserved (Note 1)
6	CLK _{EEDID} (Note 2,4)
7	Data _{EEDID} (Note 2,4)
8	ReIN0-
9	ReIN0+
10	GND
11	RelN1-
12	ReIN1+
13	GND
14	ReIN2-
15	ReIN2+

Pin #	Signal Name
16	GND
17	ReCLKIN-
18	ReCLKIN+
19	GND
20	RoIN0-
21	RoIN0+
22	GND
23	RolN1-
24	RolN1+
25	GND
26	RolN2-
27	RolN2+
28	GND
29	RoCLKIN-
30	RoCLKIN+

Note:

- 1. 'Reserved' pins are not allowed to connect any other line.
- This LCD Module complies with "VESA ENHANCED EXTENDED DISPLAY IDENTIFICATION DATA STANDARD Release A, Revision 1" and supports "EEDID version 1.3". This module uses Serial EEPROM AT24C02-10TI-2.7 (ATMEL) or compatible as a EEDID function.
- 3. V_{EEDID} power source shall be the current limited circuit which has not exceeding 1A. (Reference Document : "Enhanced Display Data Channel (E-DDC[™]) Proposed Standard", VESA)
- 4. Both CLK_{EEDID} line and Data_{EEDID} line are pulled-up with 10K ohm resistor to V_{EEDID} power source line at LCD panel, respectively.

Voltage levels of all input signals are LVDS compatible (except VDD, EEDID).

Refer to "Signal Electrical Characteristics for LVDS", for voltage levels of all input signals.

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5.3 Interface Signal Description

		1
PIN #	SIGNAL NAME	Description
1	GND	Ground
2	VDD	+3.3V Power Supply
3	VDD	+3.3V Power Supply
4	V _{EEDID}	EEDID 3.3V Power Supply
5	Reserved	Reserved
6		EEDID Clock
7	Data _{EEDID}	EEDID Data
8	ReIN0-	Negative LVDS differential data input (Even R0-R5, G0)
9	ReIN0+	Positive LVDS differential data input (Even R0-R5, G0)
10	GND	Ground
11	RelN1-	Negative LVDS differential data input (Even G1-G5, B0-B1)
12	RelN1+	Positive LVDS differential data input (Even G1-G5, B0-B1)
13	GND	Ground
14	ReIN2-	Negative LVDS differential data input (Even B2-B5, HSYNC, VSYNC, DSPTMG)
15	ReIN2+	Positive LVDS differential data input (Even B2-B5, HSYNC, VSYNC, DSPTMG)
16	GND	Ground
17	ReCLKIN-	Negative LVDS differential clock input (Even)
18	ReCLKIN+	Positive LVDS differential clock input (Even)
19	GND	Ground
20	RoIN0-	Negative LVDS differential data input (Odd R0-R5, G0)
21	RoIN0+	Positive LVDS differential data input (Odd R0-R5, G0)
22	GND	Ground
23	RoIN1-	Negative LVDS differential data input (Odd G1-G5, B0-B1)
24	RoIN1+	Positive LVDS differential data input (Odd G1-G5, B0-B1)
25	GND	Ground
26	RoIN2-	Negative LVDS differential data input (Odd B2-B5)
27	RoIN2+	Positive LVDS differential data input (Odd B2-B5)
28	GND	Ground
29	RoCLKIN-	Negative LVDS differential clock input (Odd)
30	RoCLKIN+	Positive LVDS differential clock input (Odd)
Note		•

Note:

- 1. Input signals of odd and even clock shall be the same timing.
- 2. The module uses a 100ohm resistor between positive and negative data lines of each receiver input.
- 3. Even: First Pixel, Odd: Second Pixel



SIGNAL NAME	Description
+RED 5 (ER5/OR5)	RED Data 5 (MSB)
+RED 4 (ER4/OR4)	RED Data 4
+RED 3 (ER3/OR3)	RED Data 3
+RED 2 (ER2/OR2)	RED Data 2
+RED 1 (ER1/OR1)	RED Data 1
+RED 0 (ER0/OR0)	RED Data 0 (LSB)
(EVEN/ODD)	
	Red-pixel Data: Each red pixel's brightness data consists of these 6 bits pixel data.
+GREEN 5 (EG5/OG5)	GREEN Data 5 (MSB)
+GREEN 4 (EG4/OG4)	GREEN Data 4
+GREEN 3 (EG3/OG3)	GREEN Data 3
+GREEN 2 (EG2/OG2)	GREEN Data 2
+GREEN 1 (EG1/OG1)	GREEN Data 1
+GREEN 0 (EG0/OG0)	GREEN Data 0 (LSB)
(EVEN/ODD)	
	Green-pixel Data: Each green pixel's brightness data consists of these 6 bits pixel data.
+BLUE 5 (EB5/OB5)	BLUE Data 5 (MSB)
+BLUE 4 (EB4/OB4)	BLUE Data 4
+BLUE 3 (EB3/OB3)	BLUE Data 3
+BLUE 2 (EB2/OB2)	BLUE Data 2
+BLUE 1 (EB1/OB1)	BLUE Data 1
+BLUE 0 (EB0/OB0)	BLUE Data 0 (LSB)
(EVEN/ODD)	
	Blue-pixel Data: Each blue pixel's brightness data consists of these 6 bits pixel data.
DTCLK	Data Clock: The typical frequency is 54MHz/36MHz.
(EVEN/ODD)	The signal is used to strobe the pixel + data and the + DSPTMG
+DSPTMG (DSP)	When the signal is high, the pixel data shall be valid to be displayed.
VSYNC (V-S)	Vertical Sync: This signal is synchronized with DTCLK.
	Only active high signal is acceptable.
HSYNC (H-S)	Horizontal Sync: This signal is synchronized with DTCLK.
VDD	Both active high/low signals are acceptable. Power Supply
GND	Ground
	EEDID 3.3V Power Supply
	EEDID 3.3V Power Supply EEDID Clock
Data _{EEDID}	EEDID Data

Note: Output signals except V_{EEDID}, CLK_{EEDID} and Data_{EEDID} from any system shall be Hi-Z state when VDD is off. VSYNC should start with active high (positive pulse) signal from when VDD is supplied and its polarity should not be changed.



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5.4 Interface Signal Electrical Characteristics

5.4.1 Signal Electrical Characteristics for LVDS Receiver

The LVDS receiver equipped in this LCD module is compatible with ANSI/TIA/TIA-644 standard.

Parameter	Symbol	Min	Max	Unit		
Differential Input High Threshold	Vth		+100	mV		
Differential Input Low Threshold	VtI	-100		mV		
Magnitude Differential Input Voltage	Vid	100	600	mV		
Common Mode Voltage	Vcm	0.825	2.4	V		

 $\Delta V cm$

Table Electrical Characteristics

Common Mode Voltage Offset

Note:

- Input signals shall be low or Hi-Z state when VDD is off.
- All electrical characteristics for LVDS signal are defined and shall be measured at the interface connector of LCD. (See Figure "Measurement system").

+|Vid|/2

-50

-|Vid|/2

+50

mV

Voltage Definitions



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Conditions Vcm=+1.2V

Vcm=+1.2V

Vth - Vtl = 200mV

Vth - Vtl = 200mV



Measurement system



Table. Switching Characteristics

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Clock Frequency	fc	51	54	57	MHz	
Cycle Time	tc	17.5	18.5	19.6	ns	
Data Setup Time (Note 2)	Tsu	700			ps	fc = 54MHz, tCCJ < 50ps,
Data Hold Time (Note 2)	Thd	700			ps	Vth-Vtl = 200mV, Vcm = 1.2V, ∆Vcm = 0
Cycle-to-cycle jitter (Note 3)	tCCJ	-150		+150	ps	
Cycle Modulation Rate (Note 4)	tCJavg			20	ps/clk	
Clock skew between LVDS ODD/EVEN Channels				1	ns	

Note 1: All values are at VDD=3.3V, Ta=25 degree C.

Note 2: See figure "Timing Definition" and "Timing Definition (detail A)" for definition.

Note 3: Jitter is the magnitude of the change in input clock period.

Note 4: This specification defines maximum average cycle modulation rate in peak-to-peak transition within any 100 clock cycles. This specification is applied only if input clock peak jitter within any 100 clock cycles is greater than 300ps.



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Timing Definition (Even)





Timing Definition (Odd)





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Timing Definition (detail A)







5.4.2 LVDS Receiver Internal Circuit



Below figure shows the internal block diagram of the LVDS receiver.

5.4.3 Recommended Guidelines for Motherboard PCB Design and Cable Selection

Following the suggestions below will help to achieve optimal results.

- Use controlled impedance media for LVDS signals. They should have a matched differential impedance of 100ohm.
- Match electrical lengths between traces to minimize signal skew.
- Isolate TTL signals from LVDS signals.
- For cables, twisted pair, twinax, or flex circuit with close coupled differential traces are recommended.



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5.5 Signal for Lamp Connector

Pin #	Signal Name		
1	Lamp High Voltage		
2	Lamp Low Voltage		

6.0 Pixel format image

Following figure shows the relationship of the input signals and LCD pixel format image.

Even and odd pair of RGB data are sampled at a time.





7.0 Parameter guide line for CFL Inverter

PARAMETER	MIN	DP-1	MAX	UNITS	CONDITION
White Luminance	-	200	-	cd/m ²	(Ta=25 deg.C)
CFL current (ICFL)	3.0	6.5	7.0	mArms	(Ta=25 deg.C)
CFL Frequency (FCFL)	40		70	KHz	(Ta=25 deg.C) (Note 1)
CFL Ignition Voltage (Vs)	1,600	-	-	Vrms	(Ta= 0 deg.C) (Note 3)
CFL Voltage (Reference)(VCFL)	-	630	-	Vrms	(Ta=25 deg.C) (Note 2)
CFL Power consumption (PCFL)	-	4.1	4.5	W	(Ta=25 deg.C) (Note 2)

*1 All of characteristics listed are measured under the condition using the Test inverter.

*2 In case of using an inverter other than listed, it is recommended to check the inverter carefully. Sometimes, interfering noise stripes appear on the screen, and substandard luminance or flicker at low power may happen.

- *3 In designing an inverter, it is suggested to check safety circuit very carefully. Impedance of CFL, for instance, becomes more than 1 [M ohm] when CFL is damaged.
- *4 Generally, CFL has some amount of delay time after applying kick-off voltage. It is recommended to keep on applying kick-off voltage for 1 [Sec] until discharge.
- *5 Reducing CFL current increases CFL discharge voltage and generally increases CFL discharge frequency. So all the parameters of an inverter should be carefully designed so as not to produce too much leakage current from high-voltage output of the inverter.
- *6 It should be employed the inverter which has 'Duty Dimming', if ICFL is less than 4[mA].
- **Note 1:** CFL discharge frequency should be carefully determined to avoid interference between inverter and TFT LCD.
- Note 2: Calculated value for reference (ICFL x VCFL = PCFL).
- **Note 3:** CFL inverter should be able to give out a power that has a generating capacity of over 1,600 voltage. Lamp units need 1,600 voltage minimum for ignition.
- **Note 4:** DP-1 (Design Point-1) is recommended Design Point.

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The following chart is Luminance versus Lamp Power for your reference.

TBD



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8.0 Interface Timings

Basically, interface timings described here is not actual input timing of LCD module but output timing of SN75LVDS86 (Texas Instruments) or equivalent.

8.1 Timing Characteristics

Timing Characteristics

Signal	Item	Symbol	MIN.	TYP.	MAX.	Unit
DTCLK	Freqency	Fdck	51	54	57	[MHz]
		Tck		18.5		[ns]
+V-Sync	Frame Rate	Fv	-	60	-	[Hz]
		Τv	-	16.67	-	[ms]
		Nv	1058	1066	2046	[lines]
	V-Active Level	Tva	15.63	46.89	969.06	[us]
		Nva	1	3	62	[lines]
	V-Back Porch	Nvb	6	12	125	[lines]
	V-Front Porch	Nvf	1	1		[lines]
+DSPTMG	V-Line	m		1050		[lines]
+H-Sync	Scan Rate	Fh	-	63.98	-	[KHz]
		Th	-	15.63	-	[us]
		Nh	762	844	1023	[Tck]
	H-Active Level	Tha		1.037		[us]
		Tha	8	56	250	[Tck]
	H-Back Porch	Thb	26	64	300	[Tck]
	H-Front Porch	Thf	8	24		[Tck]
+DSPTMG	Display	Thd		12.96		[us]
+DATA	Data Even/Odd	n		1400		[dots]

Note: Positive Hsync polarity is recommended. Only positive Vsync is acceptable.

When there are invalid timing, Display appears black pattern.

Synchronous Signal Defects and enter Auto Refresh for LCD Module protection Mode.



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8.2 Timing Definition

8.2.1 Vertical Timing Table

Support mode	Tvblk	m	Tvf VSYNC	Tv,Nv	Tva VSYNC	Tvb VSYNC
	Vertical	Active Field Front Porch		Frame Time	Width	Back Porch
	Blanking					
1400 x 1050	0.250 ms	16.411 ms	0.016 ms	16.661 ms	0.047 ms	0.188 ms
(H line rate : 15.63 us)	(16 lines)	(1050 lines)	(1 line)	(1066 lines)	(3 lines)	(12 lines)



8.2.2 Horizontal Timing Table

Support mode	Thblk	Thd	Thf	Th,Nh	Tha	Thb HSYNC
	Horizontal	Active Field	HSYNC	H Line Time	HSYNC	Back Porch
	Blanking		Front Porch		Width	
1400 x 1050	2.667 us	12.963 us	0.444 us	15.630 us	1.037 us	1.185 us
Dotclock : 108.000	(288 dots)	(1400 dots)	(48 dots)	(1688 dots)	(112 dots)	(128 dots)
MHz (54.000MHz x2)						





9.0 **Power Consumption**

Input power specifications are as follows;

SYMBOL	PARAMETER	Min	Тур	Max	UNITS	CONDITION
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[V]	Load Capacitance 50 uF
PDD	VDD Power			2.6	[W]	MAX. Pattern,
						VDD=3.6[V]
PDD	VDD Power		2.0	2.5	[W]	All White Pattern,
						VDD=3.3[V]
IDD	VDD Current			800	[mA]	MAX Pattern,
						VDD=3.0[V]
IDD	VDD Current		610		[mA]	All White Pattern,
						VDD=3.3[V]
VDDrp	Allowable Logic/LCD			100	[mVp-p]	
	Drive Ripple Voltage					
VDDns	Allowable Logic/LCD			100	[mVp-p]	
	Drive Ripple Noise					

Note: MAX. Pattern : Horizontal pixel Stripe.



10.0 Power ON/OFF Sequence

VDD power and lamp on/off sequence is as follows. Interface signals are also shown in the chart.

Signals from any system shall be Hi-Z state or low level when VDD is off.





11.0 Mechanical Characteristics





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12.0 National Test Lab Requirement

The display module will satisfy all requirements for compliance to

UL 60950, 3rd Edition	U.S.A. Information Technology Equipment
CAN/CSA-C22.2 No. 60950-00	Canada, Information Technology Equipment
IEC 60950 (3rd. Ed.)	International, Information Technology Equipment
EN 60950 (3rd. Ed.)	International, Information Technology Equipment
	(European Norm for IEC60950)

Conditions of Acceptability

For use only in or with complete equipment where the acceptability of the combination is determined by Underwriters laboratories Inc.

When installed in an end-product, consideration must be given to the following:

- The terminals and connectors are suitable for factory wiring only.
- The component has been evaluated for use in a Pollution Degree 2 environment.
- Need for fire and/or electrical enclosures hall be considered in end puroduct.
- The unit is intended to be supplied by SELV and Limited Power Source. Also separated from electrical parts, which may produce high temperature that could cause ignition by at least 13 mm of air or by a solid barrier of material of V-1 minimum due to materials having no flammability rating.
- Back light lamp is rated 630 V rms, 6.5 mA, and intended to be supplied by Limited Current Circuit.
- Insulation between Backlight circuit and other SELV circuit has not been evaluated. Additional is
 consideration shall be made if backlight is supplied by a source other than limited current circuit.

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